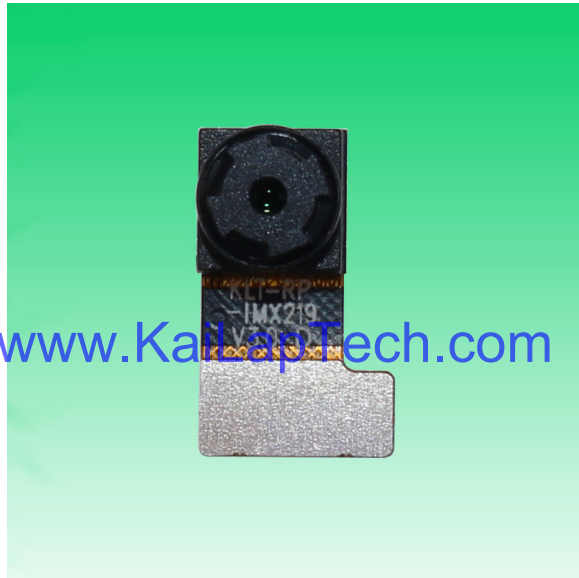
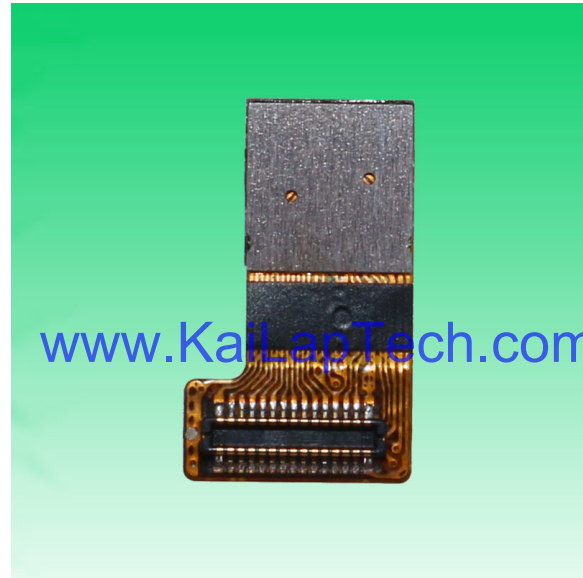


KLT-RP-IMX219 V3.0

8MP Sony IMX219 MIPI Interface Fixed Focus Camera Module



Front View



Back View

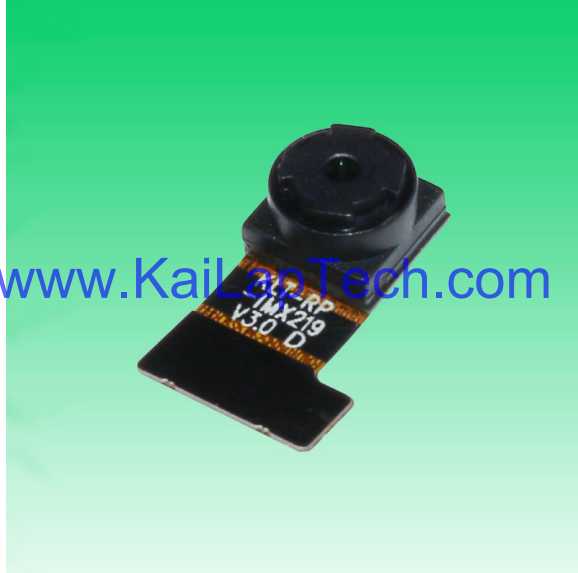
Specifications

Camera Module No.	KLT-RP-IMX219 V3.0
Resolution	8MP
Image Sensor	IMX219
Sensor Type	1/4"
Pixel Size	1.12 um x 1.12 um
EFL	2.93 mm
F.NO	2.00
Pixel	3264 x 2448
View Angle	75.0°(DFOV) 62.8°(HFOV) 49.3°(VFOV)
Lens Dimensions	6.50 x 6.50 x 4.62 mm
Module Size	14.80 x 8.85 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Model	KLT-LENS-9570A3
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +60°C
Mating Connector	DF37NB-30DS-0.4V



KLT-RP-IMX219 V3.0

8MP Sony IMX219 MIPI Interface Fixed Focus Camera Module



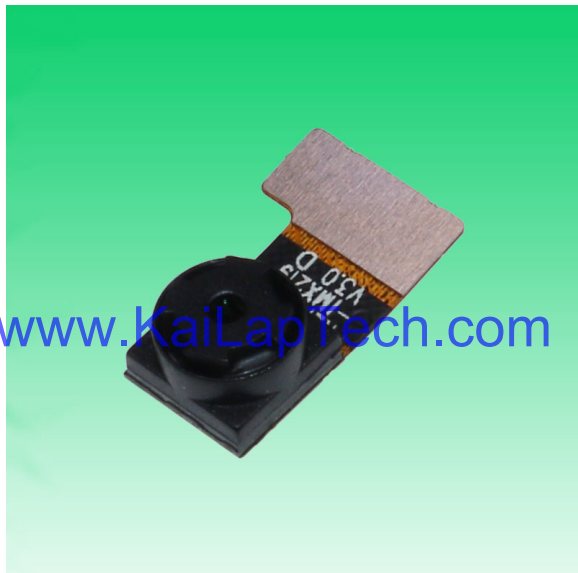
Top View



Side View

www.KaiLapTech.com

www.KaiLapTech.com



Bottom View

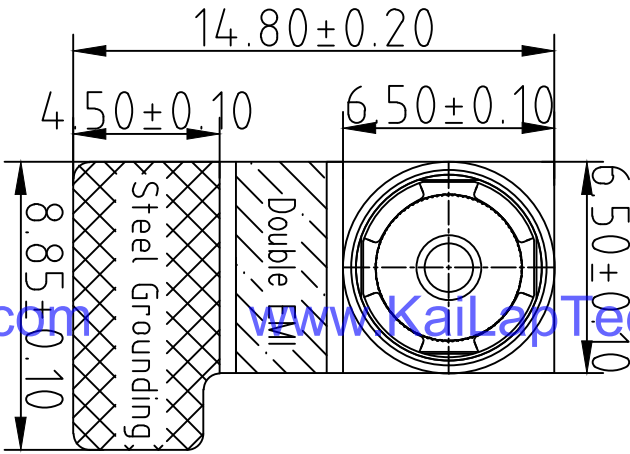


Mating Connector

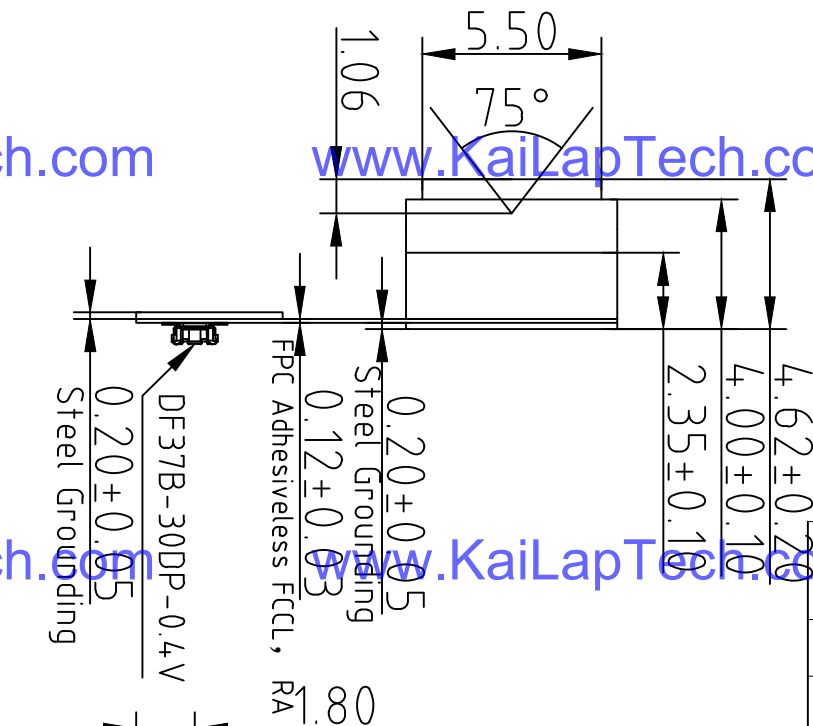
ROHS

PIN SIGNAL

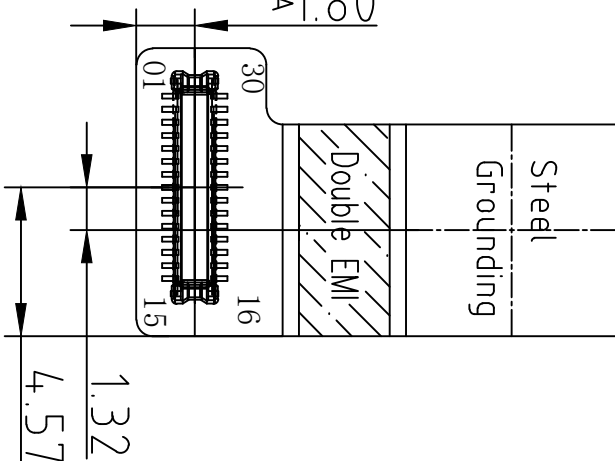
1	NC
2	NC
3	DVDD1.8V
4	DVDD1.5V
5	NC
6	DGND
7	XCLK
8	DGND
9	AGND
10	AVDD2.8V
11	NC
12	DGND
13	MDP3
14	MDN3
15	DGND
16	DGND
17	MDN2
18	MDP2
19	DGND
20	MDN1
21	MDP1
22	DGND
23	MDN0
24	MDP0
25	DGND
26	MCN
27	MCP
28	PWDN
29	SCL
30	SDA



TOP VIEW



SIDE VIEW



BOTTOM VIEW

NOTE:

1. The device slave address: 0x20(w); 0x21(r)

Parameters:

1、Sensor specification:

Image Sensor: IMX219
 Pixel: 1.12umx1.12um
 Lens Type: 1/4
 Important Voltage Description: DVDD1.2V
 (external power supply);

2 Lens specification:

FOV: 75°
 F/NO: 2.0
 TV Distortion: <1.0%
 Focal length: 2.93mm
 Composition: 4P

Kai Lap Technologies Group Ltd

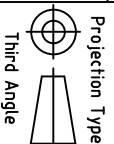
Designed By

Kevin

Model Name: KLT-RP-IMX219 V3.0

Checked By

Aouly Yan



Unit: mm
 Scale: 1:1

Material: -----
 Sheet: 1 of 1

Version: 1/0

Version Mark	Information	Date
V1.0	PD First Version	2016-08-31
V2.0	Change the layout	2016-10-31
V3.0	Change lens	2019-01-24

A

B

C

D

E

3

2

1

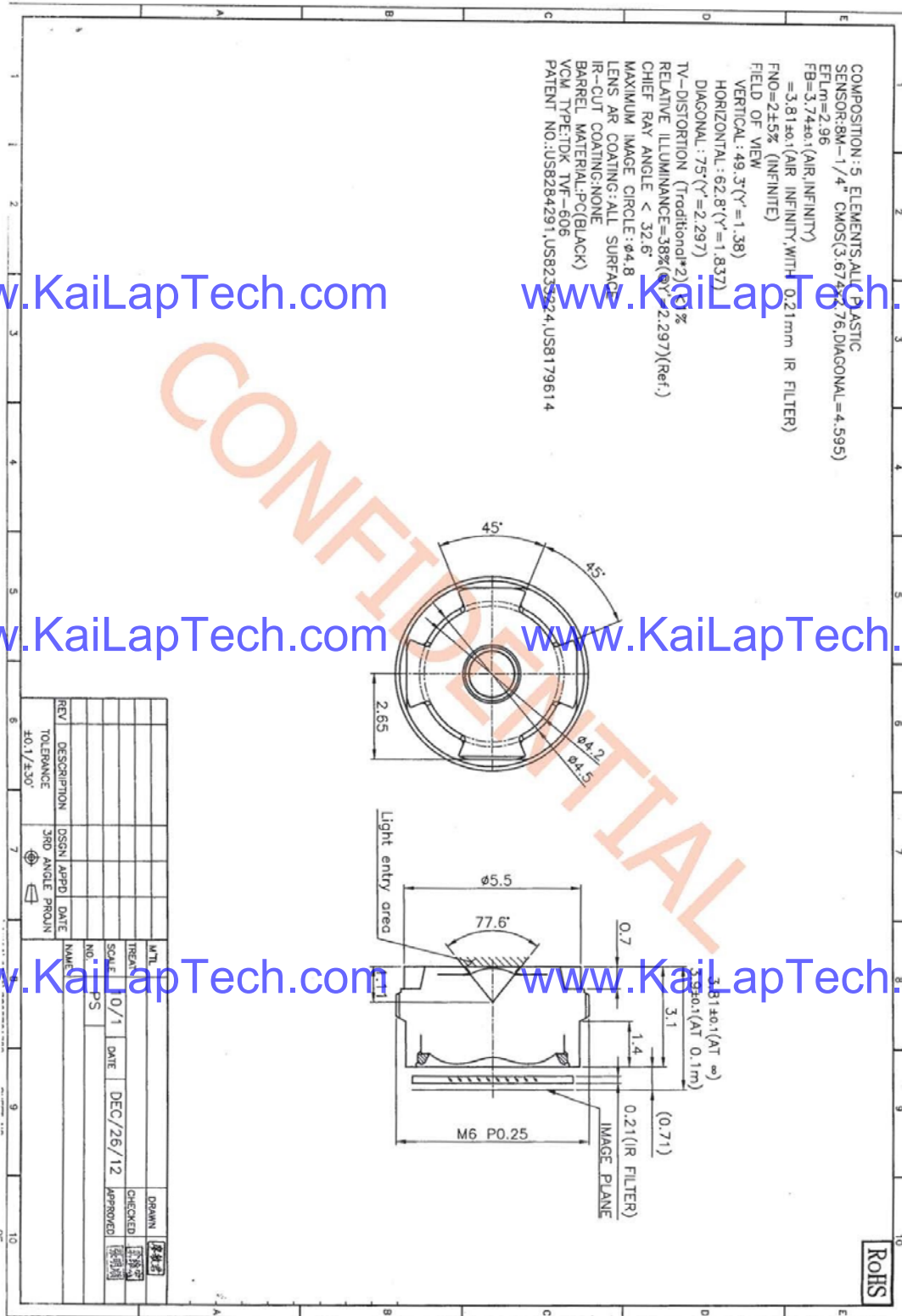
3

2

1



Lens Model: KLT-LENS-9570A3



www.KaiLapTech.com

www.KaiLapTech.com

www.KaiLapTech.com

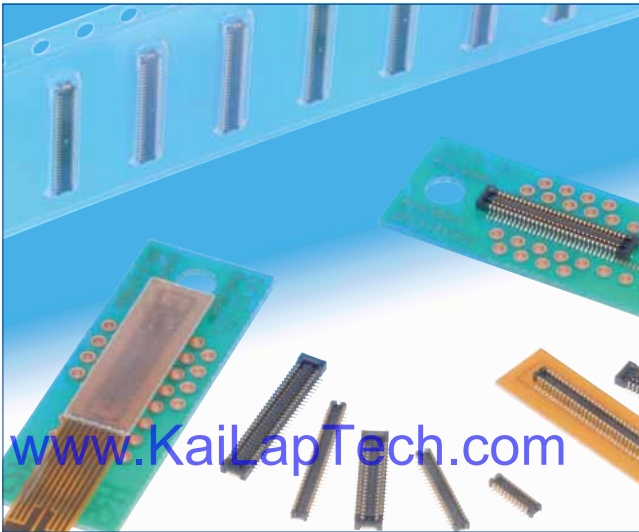
www.KaiLapTech.com

www.KaiLapTech.com

www.KaiLapTech.com

0.4mm Pitch, 0.98/1.5mm Mated Height, Board-to-Board / Board-to-FPC Connectors

DF37 Series



Further reduction of the board space.

Comparison of board mounting space

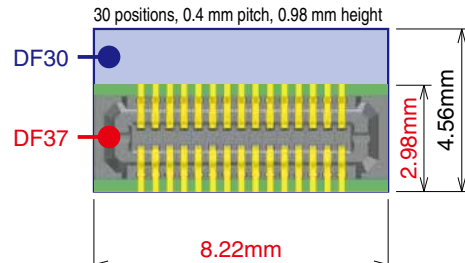


Fig.1

Features

1. Reduced size and board-occupied area

With the mated height of 0.98/1.5mm, width of 2.98mm and length of 8.22mm (30 positions) the connectors are one of the smallest in its class. Also 2.6mm depth short-lead type is available. (Fig.1)

Sufficiently large flat areas allow pick-up with vacuum nozzles of automatic placement equipment.

2. Reliable electrical and mechanical connection

Despite its small mated height, unique contact configuration, with a 2-point contacts and effective mating length of 0.25mm, assures highly reliable connection while confirming a complete mating with a definite tactile feel.

3. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces, the connectors will self-align within 0.3mm.

4. Physical shock and vibration protection

2-point contact assures electrical connection in a shock or vibration applications. (Fig.2)

5. Solder wicking prevention

Nickel barriers (receptacles) and unique forming of the contacts (headers) prevent un-intentional solder wicking.

6. Contamination protection

Insulator walls protect the contact areas against flux splatter or other physical particles contamination. (Fig.3)

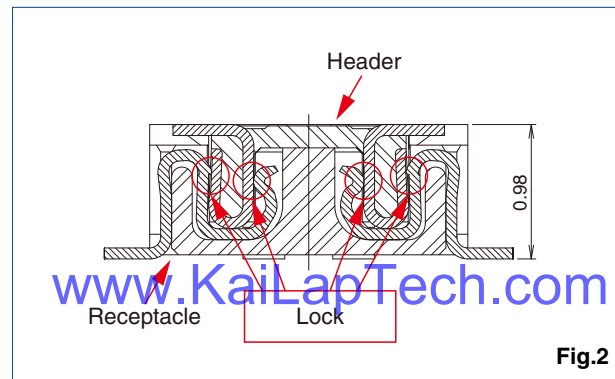
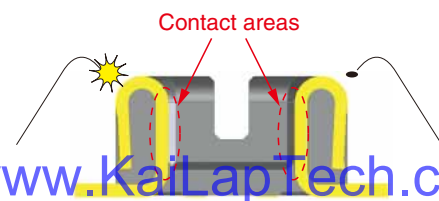


Fig.2

Splatter protection



Contact areas are not exposed to the outside penetration of the flux or other physical particles.

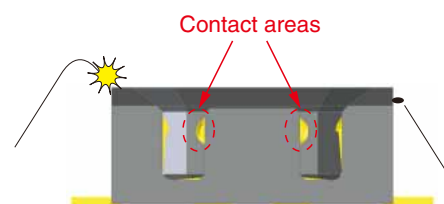


Fig.3

Product Specifications

Ratings	Current rating	0.3A	Operating temperature range	-35°C to +85°C (Note 1)	Storage temperature range	-10°C to +60°C (Note 2)
	Voltage rating	30V AC, DC	Operating humidity range	RH 20% to 80%	Storage humidity range	RH 40% to 70% (Note 2)

Item	Specification	Conditions
1. Insulation resistance	50MΩ min	100V DC
2. Withstanding voltage	No flashover or insulation breakdown	100V AC / 1 minute
3. Contact resistance	100mΩ max.	20mV AC, 1kHz, 1mA
4. Vibration	No electrical discontinuity of 1μs or longer No damage or parts dislocation	Frequency : 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours, 3 axis
5. Humidity	Contact resistance : 100mΩ max., Insulation resistance : 25MΩ min.	96 hours at 40 ±2°C and humidity of 90 to 95% No damage or parts dislocation
6. Temperature cycle	Contact resistance : 100mΩ max., Insulation resistance : 50MΩ min. No damage or parts dislocation	-55°C → 5 to 35°C → 85°C → 5 to 35°C Time: 30 min. → 10 min. → 30 min. → 10 min. 5 cycles
7. Durability	Contact resistance : 100mΩ max.	10 cycles
8. Resistance to soldering heat	No deformation of components affecting performance	Reflow : At the recommended temperature profile Manual soldering : 350°C for 3 seconds

Note 1 : Includes temperature rise caused by current flow.

Note 2 : The term "storage" here refers to products stored for a long period prior to board mounting and use.

The operating temperature and humidity range covers the non-conducting condition of connectors after board mounting and the temporary storage conditions of transportation, etc.

Materials / Finish

Receptacle

Part	Material	Finish	Remarks
Insulator	LCP	Color: Black	UL94V-0

Header

Part	Material	Finish	Remarks
Contacts	Phosphor bronze	Gold plated	

Product Number Structure

Refer to the chart below when determining the product specifications from the product number.

Please select from the product numbers listed in this catalog when placing orders.

●Receptacles **DF 37 # - (***) - * DS - 0.4 V (**)**

①
②
③
④
⑤
⑥
⑦
⑧

① Series name : DF37	⑤ Connector style DS : Receptacle
② Configuration NB : With metal fittings NC : Without metal fittings SB : Short-lead type with metal fittings	⑥ Contact pitch : 0.4mm
③ Stacking height Blank : 0.98mm, 1.5 : 1.5mm	⑦ Terminal type : SMT vertical mount
④ Number of contacts	⑧ Packaging (51) Stacking height 0.98mm : Embossed tape packaging (8,000 pcs/reel) (51) Stacking height 1.5mm : Embossed tape packaging (5,000 pcs/reel) (53) : Embossed tape packaging (1,000 pcs/reel)

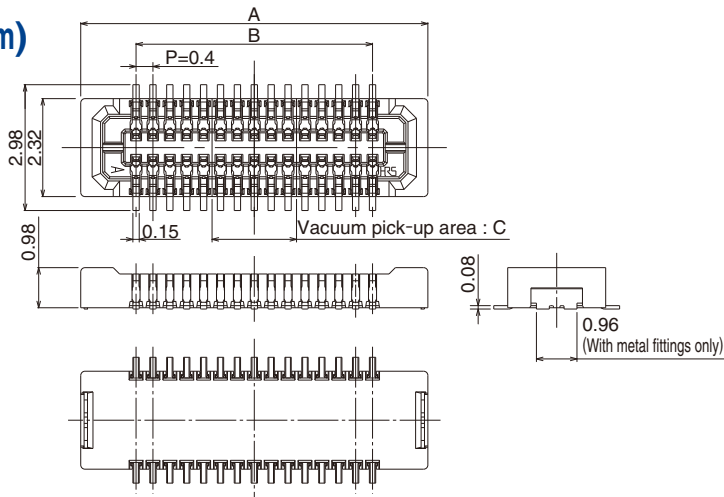
●Headers **DF 37 # - * DP - 0.4 V (**)**

①
②
③
④
⑤
⑥
⑦

① Series name : DF37	④ Connector style DP : Header
② Configuration B : With metal fittings C : Without metal fittings	⑤ Contact pitch : 0.4mm
③ Number of contacts	⑥ Terminal type V : SMT vertical mount
	⑦ Packaging (51) : Embossed tape packaging (8,000 pcs/reel) (53) : Embossed tape packaging (1,000 pcs/reel)

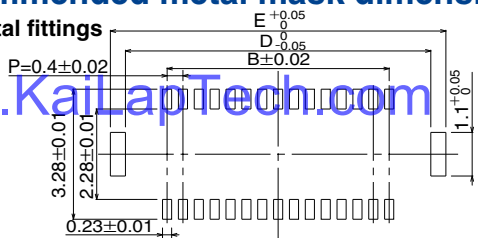
Note : The short-lead type is only available for the receptacle side (with hardware).

■ Receptacles (Stacking Height=0.98mm)



◆ Recommended metal mask dimensions

With metal fittings

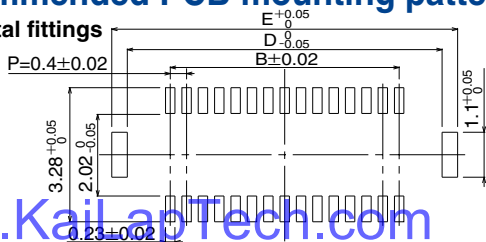


Without metal fittings

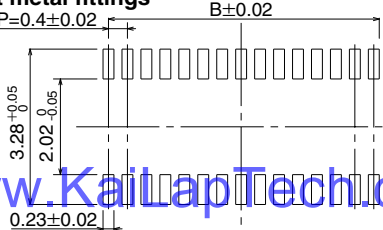


◆ Recommended PCB mounting pattern

With metal fittings



Without metal fittings



● With metal fittings

Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C	D	E
DF37NB-10DS-0.4V(51)	684-3301-6 51	10	4.22	1.6	0.8	3.7	4.46
DF37NB-16DS-0.4V(51)	684-3302-9 51	16	5.42	2.8	1.2	4.9	5.66
DF37NB-20DS-0.4V(51)	684-3303-1 51	20	6.22	3.6	1.6	5.7	6.46
DF37NB-24DS-0.4V(51)	684-3304-4 51	24	7.02	4.4	2	6.5	7.26
DF37NB-30DS-0.4V(51)	684-3305-7 51	30	8.22	5.6		7.7	8.46
DF37NB-34DS-0.4V(51)	684-3082-4 51	34	9.02	6.4	2.4	8.5	9.26
DF37NB-40DS-0.4V(51)	684-3306-0 51	40	10.22	7.6		9.7	10.46
DF37NB-44DS-0.4V(51)	684-3407-7 51	44	11.02	8.4	2.8	10.5	11.26
DF37NB-50DS-0.4V(51)	684-3307-2 51	50	12.22	9.6		11.7	12.46
DF37NB-60DS-0.4V(51)	684-3308-5 51	60	14.22	11.6	3.2	13.7	14.46
DF37NB-70DS-0.4V(51)	684-3409-2 51	70	16.22	13.6	3.6	15.7	16.46

● Without metal fittings

Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C
DF37NC-10DS-0.4V(51)	684-3309-8 51	10	4.22	1.6	0.8
DF37NC-16DS-0.4V(51)	684-3310-7 51	16	5.42	2.8	1.2
DF37NC-20DS-0.4V(51)	684-3311-0 51	20	6.22	3.6	1.6
DF37NC-24DS-0.4V(51)	684-3312-2 51	24	7.02	4.4	2
DF37NC-30DS-0.4V(51)	684-3313-5 51	30	8.22	5.6	
DF37NC-34DS-0.4V(51)	684-3083-7 51	34	9.02	6.4	2.4
DF37NC-40DS-0.4V(51)	684-3314-8 51	40	10.22	7.6	
DF37NC-44DS-0.4V(51)	684-3324-1 51	44	11.02	8.4	2.8
DF37NC-50DS-0.4V(51)	684-3315-0 51	50	12.22	9.6	
DF37NC-60DS-0.4V(51)	684-3316-3 51	60	14.22	11.6	3.2
DF37NC-70DS-0.4V(51)	684-3084-0 51	70	16.22	13.6	3.6

Note 1 : Tape and reel packaging (8,000 pcs/reel). Order by number of reels.

Note 2 : This connector is NOT polarized.

[Product Brief]

Ver.1.0

IMX219PQ

Diagonal 4.60mm (Type 1/4.0) 8M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

Description

IMX219PQ is a diagonal 4.60mm (Type 1/4.0) CMOS active pixel type image sensor with a square pixel array and 8.08M effective pixels. This chip operates with three power supplies, analogue 2.8V, digital 1.2 V, and IF 1.8 V, and has low power consumption. High sensitivity, low dark current, and no smear are achieved through the adoption of R, G, and B primary color pigment mosaic filters. This chip features an electronic shutter with variable charge-storage time.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony sales representative if you have any questions.

Functions and Features

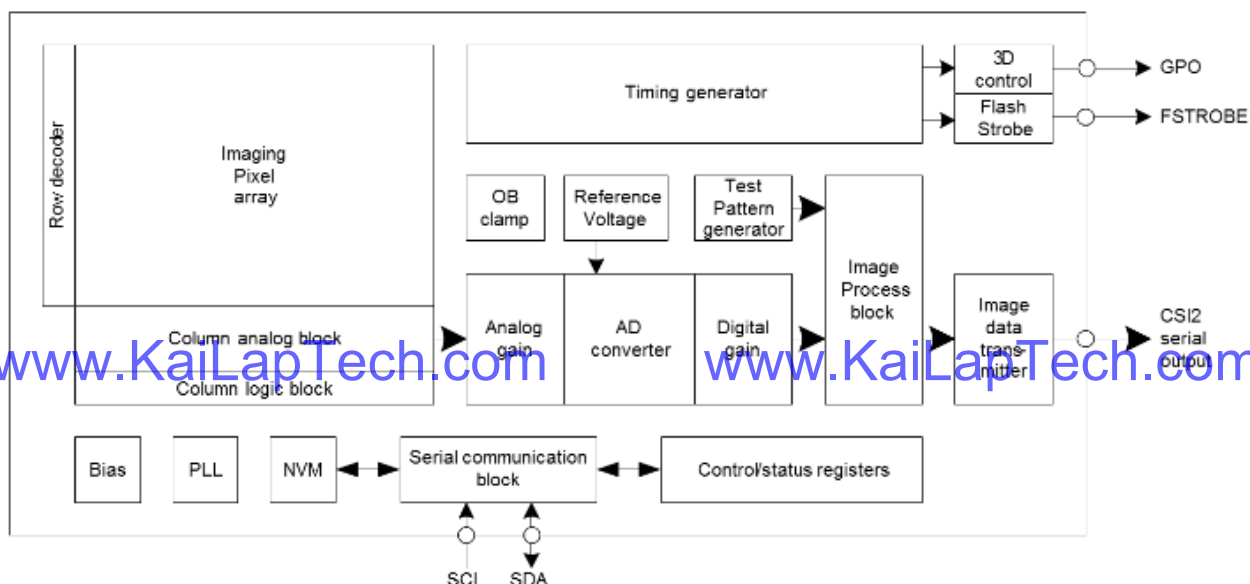
- ◆ Back-illuminated CMOS image sensor Exmor R™
- ◆ 2-wire serial communication circuit on chip
- ◆ CSI2 serial data output (selection of 4lane/2lane)
- ◆ Timing generator, H and V driver circuits on chip
- ◆ CDS/PGA on chip
- ◆ 10-bit A/D converter on chip
- ◆ Automatic optical black (OB) clamp circuit on chip
- ◆ PLL on chip (rectangular wave)
- ◆ High sensitivity, low dark current, no smear
- ◆ Excellent anti-blooming characteristics
- ◆ Variable-speed shutter function (1 H units)
- ◆ R, G, B primary color pigment mosaic filters on chip
- ◆ Max. 30frame/s in all-pixel scan mode
- ◆ Pixel rate: 280 [Mpixel/s] (All-pixels mode)
- ◆ 180 frame/s @720p with 2x2 analog (special) binning, 60 frame/s @1080p with V-crop
- ◆ Datarate: Max.755Mbps/lane (@4lane), 912Mbps/Lane(@2lane)

Device Structure

- ◆ CMOS image sensor
- ◆ Image size : Diagonal 4.60mm (Type 1/4.0)
- ◆ Total number of pixels : 3296(H) × 2512(V) approx. 8.28M pixels
- ◆ Number of effective pixels : 3296(H) × 2480(V) approx. 8.17M pixels
- ◆ Number of active pixels : 3280(H) × 2464(V) approx. 8.08M pixels
- ◆ Chip size : 5.095mm (H) × 4.930mm (V) (w/ Scribe)
- ◆ Unit cell size : 1.12µm (H) × 1.12µm (V)
- ◆ Substrate material : Silicon

Functional Description

www.KaiLapTech.com **Block diagram** www.KaiLapTech.com



www.KaiLapTech.com

www.KaiLapTech.com



* Exmor R is a trademark of Sony Corporation. The Exmor R is a Sony's CMOS image sensor with significantly enhanced imaging characteristics including sensitivity and low noise by changing fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type.

Sony reserves the right to change products and specifications without prior notice.

This information does not convey any license by any implication or otherwise under any patents or other right.

Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.



Camera Module Pinout Definition Reference Chart

OmniVision	Sony	Samsung	On-Semi	Aptina	Himax	GalaxyCore	PixArt	SmartSens	Sensors
Pin Signal		Description							
DGND GND		ground for digital circuit							
AGND		ground for analog circuit							
PCLK DCK		DVP PCLK output							
XCLR PWDN XSHUTDOWN STANDBY		power down active high with internal pull-down resistor							
MCLK XVCLK XCLK INCK		system input clock							
RESET RST		reset active low with internal pull-up resistor							
NC NULL		no connect							
SDA SIO_D SIOD		SCCB data							
SCL SIO_C SIOC		SCCB input clock							
VSYNC XVS FSYNC		DVP VSYNC output							
HREF XHS		DVP HREF output							
DOVDD		power for I/O circuit							
AFVDD		power for VCM circuit							
AVDD		power for analog circuit							
DVDD		power for digital circuit							
STROBE FSTROBE		strobe output							
FSIN		synchronize the VSYNC signal from the other sensor							
SID		SCCB last bit ID input							
ILPWM		mechanical shutter output indicator							
FREQ		frame exposure / mechanical shutter							
GPIO		general purpose inputs							
SLASEL		I2C slave address select							
AFEN		CEN chip enable active high on VCM driver IC							
MIPI Interface									
MDN0 DN0 MD0N DATA_N DMO1N		MIPI 1st data lane negative output							
MDP0 DP0 MD0P DATA_P DMO1P		MIPI 1st data lane positive output							
MDN1 DN1 MD1N DATA2_N DMO2N		MIPI 2nd data lane negative output							
MDP1 DP1 MD1P DATA2_P DMO2P		MIPI 2nd data lane positive output							
MDN2 DN2 MD2N DATA3_N DMO3N		MIPI 3rd data lane negative output							
MDP2 DP2 MD2P DATA3_P DMO3P		MIPI 3rd data lane positive output							
MDN3 DN3 MD3N DATA4_N DMO4N		MIPI 4th data lane negative output							
MDP3 DP3 MD3P DATA4_P DMO4P		MIPI 4th data lane positive output							
MCN CLKN CLK_N DCKN		MIPI clock negative output							
MCP CLKP MCP CLK_P DCKN		MIPI clock positive output							
DVP Parallel Interface									
D0 DO0 Y0		DVP data output port 0							
D1 DO1 Y1		DVP data output port 1							
D2 DO2 Y2		DVP data output port 2							
D3 DO3 Y3		DVP data output port 3							
D4 DO4 Y4		DVP data output port 4							
D5 DO5 Y5		DVP data output port 5							
D6 DO6 Y6		DVP data output port 6							
D7 DO7 Y7		DVP data output port 7							
D8 DO8 Y8		DVP data output port 8							
D9 DO9 Y9		DVP data output port 9							
D10 DO10 Y10		DVP data output port 10							
D11 DO11 Y11		DVP data output port 11							



your **BEST** camera module partner

Cameras Applications



www.KaiLapTech.com



www.KaiLapTech.com



www.KaiLapTech.com

www.KaiLapTech.com



www.KaiLapTech.com



www.KaiLapTech.com





Camera Reliability Test

Reliability Inspection Item		Testing Method	Acceptance Criteria	
Category	Item			
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional	
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional





Inspection Item		Inspection Method	Standard of Inspection	
Category	Item			
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Gap	The Naked Eye	Meet the Height Standard
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard
		Contamination	The Naked Eye	No Effect On Resolution Standard
		Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
	Function	Image	No Communication	Test Board
Bright Pixel			Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center
Blurry			The Naked Eye	Not Allowed
No Image			The Naked Eye	Not Allowed
Vertical Line			The Naked Eye	Not Allowed
Horizontal Line			The Naked Eye	Not Allowed
Light Leakage			The Naked Eye	Not Allowed
Blinking Image			The Naked Eye	Not Allowed
Bruise			Inspection Jig	Not Allowed
Resolution			Chart	Follows Outgoing Inspection Chart Standard
Color			The Naked Eye	No Issue
Noise			The Naked Eye	Not Allowed
Corner Dark			The Naked Eye	Less Than 100px By 100px
Color Resolution			The Naked Eye	No Issue
Dimension	Height	The Naked Eye	Follows Approval Data Sheet	
	Width	The Naked Eye	Follows Approval Data Sheet	
	Length	The Naked Eye	Follows Approval Data Sheet	
	Overall	The Naked Eye	Follows Approval Data Sheet	



KLT Package Solutions

KLT Camera Module



Complete with Lens Protection Film



Tray with Grid and Space



Place Cameras on the Tray





Camera Modules Package Solution

Full Tray of Cameras



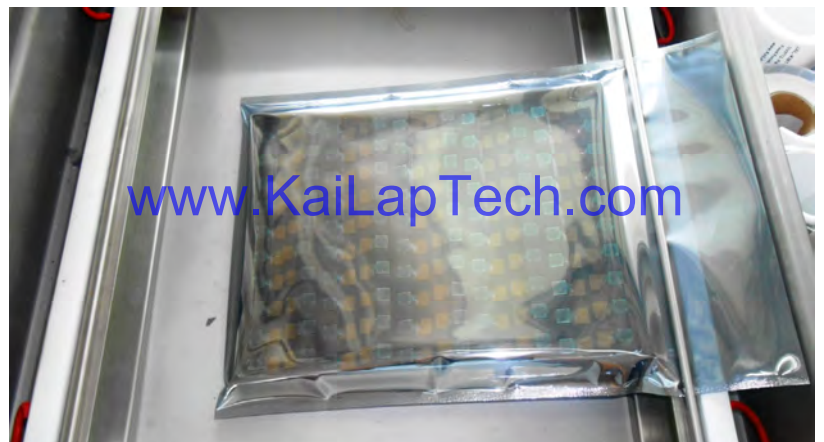
Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag





Camera Modules Package Solution

Sealed Vacuum Bag with Labels

- 1. Model and Description 2. Quantity 3. Shipping Date 4. Caution**





CMOS CAMERA MODULES



your BEST camera module partner

Large Order Package Solution

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays



www.KaiLapTech.com

www.KaiLapTech.com

Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting Box



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.



CMOS CAMERA MODULES



your BEST camera module partner

Small Order Package Solution

Place Foam Sheets and Trays into Small Box



www.KaiLapTech.com

www.KaiLapTech.com

Package in Small Box for Shipment

Foam Sheets are Nicely Fitting the Small Box



www.KaiLapTech.com

www.KaiLapTech.com

Place Small Boxes into Larger Box



www.KaiLapTech.com



www.KaiLapTech.com

www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.



Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



Carbon Box Ready for Shipment

1. Delivery Address and Phone No.
2. Box No. and Ship Date
3. Fragile Caution





Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



Sample Labels on the Small Bag

1. Camera Module or Connector Model
2. Shipping Date and Quantity
3. Caution





your BEST camera module partner

Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box



Connectors Box Ready for Shipment



Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.

www.KaiLapTech.com

www.KaiLapTech.com



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.





CMOS CAMERA MODULES



your BEST camera module partner

KLT Strength

Powerful Factory



www.KaiLapTech.com

www.KaiLapTech.com

Professional Service



www.KaiLapTech.com

www.KaiLapTech.com

Promised Delivery



www.KaiLapTech.com

www.KaiLapTech.com



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.